

FS236BQ

Half-Bridge IPM

Description

FS236BQ is a half-bridge module with high performance and high reliability, using for small power motor applications such as fan motor and bump, consisting of built-in 2 fast recovery MOSFET and half-bridge HVIC for gate driving.

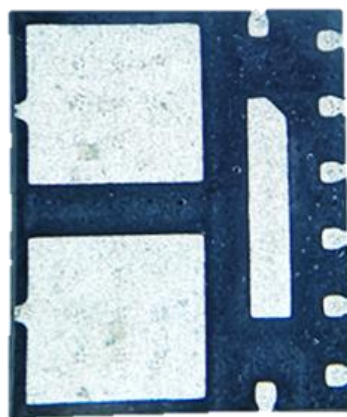
FS236BQ has built-in VCC and VB under-voltage (UVLO) protection to prevent the power semiconductor devices from operation under very low voltage. The FS236BQ has also built-in cross-conduction and input signal filtering to prevent input noise.

FS236BQ is compact and suitable for built-in motors or any other applications requiring the compact installation.

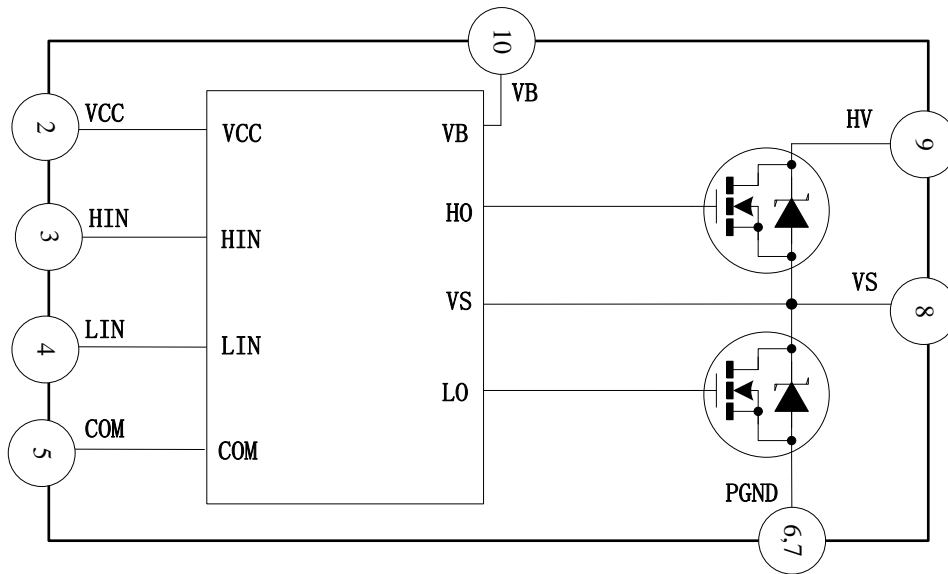
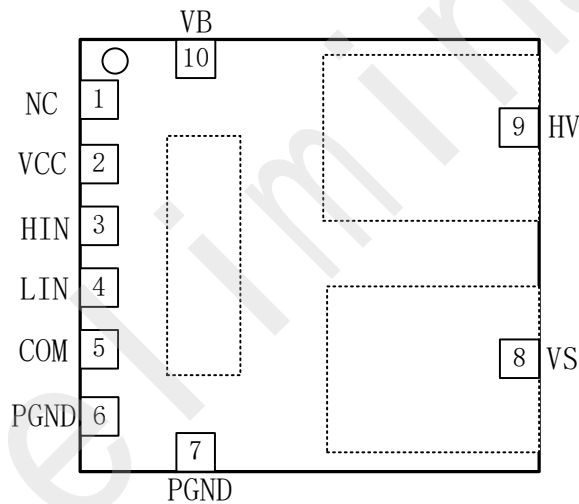
Features

- Built-in 600V3A fast recovery MOSFET
- Built-in high voltage Gate driver circuit(HVIC)
- Power supply pressure range: 13.5V ~20V
- 3.3V/5V logic input compatible, active high HIN and LIN
- Under-voltage lockout for all channels
- Optimized dV/dt for loss and EMI trade offs
- Cross-conduction prevention logic
- Isolation 1500V_{RMS} min
- ROHS compliant

Package(QFN10L-5*6)



QFN10L-5*6

Internal Electrical Schematic

Module Pin-Out Description


Pin	Name	Description
1	NC	Not Connect
2	VCC	Low side and logic fixed supply
3	HIN	Logic Input for High Side (Active High)
4	LIN	Logic Input for Low Side (Active High)
5	COM	Low Side Gate Drive Return
6,7	PGND	Low Side Source Connection
8	VS	Phase Output
9	HV	DC Bus
10	VB	High Side Floating Supply

Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the module may occur. These are not tested at manufacturing. All voltage parameters are absolute voltages referenced to VSS unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air condition.

Symbol	Description	Min	Max	Unit
BV _{DSS}	MOSFET Blocking Voltage	-	600	V
I _{O 25}	DC output current per MOSFET @ TC=25°C (Note1)	-	3	A
I _{O 80}	DC output current per MOSFET @ TC=80°C (Note2)	-	2.1	A
I _{OP}	Peak output current per MOSFET @ TC=25°C	-	8	A
P _d	Power dissipation per MOSFET @ TC =25°C	-	3.57	W
T _J	Maximum Operating Junction Temperature	-	150	°C
T _L	Lead temperature (soldering 30 seconds)	-	260	°C
T _S	Storage Temperature Range	-40	150	°C
R _{thJA}	Thermal resistance, junction to case, each MOSFET	-	35	°C/W
V _B	High side floating supply voltage	-0.3	V _S + 20 V	V
V _S	High side floating supply offset voltage	V _B - 20	V _B + 0.3 V	V
V _{CC}	Low Side fixed supply voltage	-0.3	20	V
V _{IN}	Logic input voltage LIN, HIN	-0.3	V _{CC} + 0.3	V
V _{ISO}	Isolation voltage(1min)(Note2)	-	1500	V

Note1: The current is calculated based on the maximum junction temperature. Package limit is 1.1A.

Note2: The current is calculated based on the maximum junction temperature. Package limit is 0.8A.

Note3: In any case, power dissipation should not exceed P_D.

Note4: Voltages above the absolute maximum ratings may damage the chip.

Recommended Operating Conditions

Symbol	Description	Min	Typ	Max	Units
HV	Positive DC Bus Input Voltage	---	300	400	V
V _{BS}	High Side Supply Voltage	13.5	15	16.5	V
V _{CC}	Low Side and Logic Supply Voltage	13.5	15	16.5	V
V _{IN}	Logic Input Voltage	COM	---	V _{CC}	V
t _{dead}	Blanking Time for Preventing Arm-Short	1.0	---	---	us
f _{PWM}	PWM Carrier Frequency	---	15	20	kHz

For proper operation, the module should be used within the recommended conditions. All voltages are absolute referenced to COM.

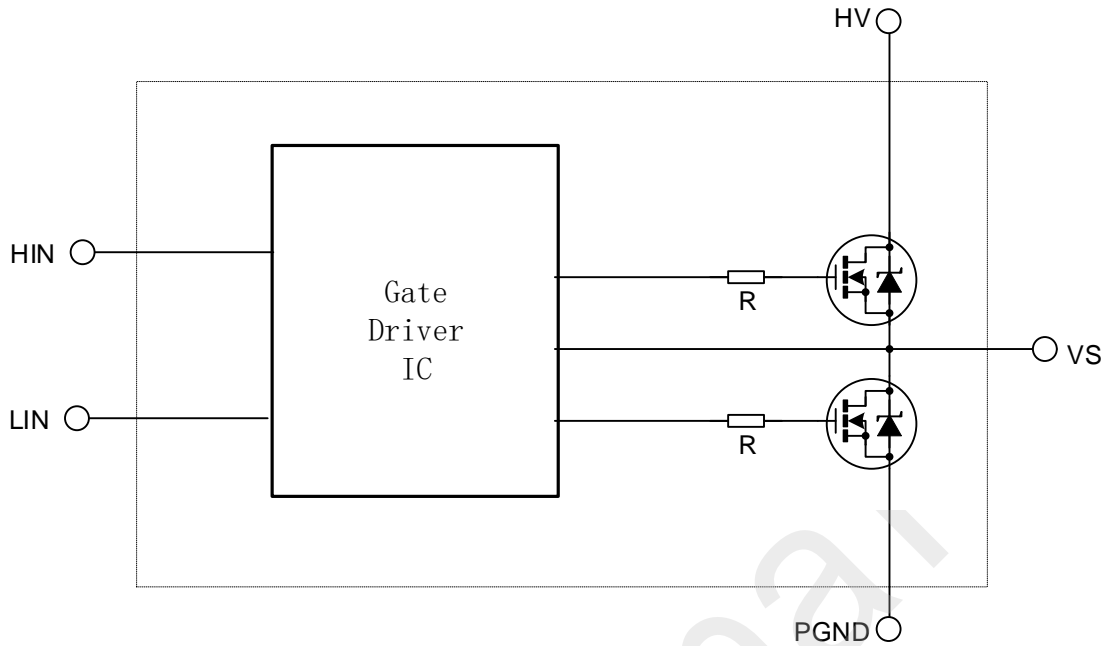
Note1: The long-term operation of the chip outside the recommended conditions may affect its reliability. It is not recommended to work in an environment that exceeds the recommended conditions.

Static Electrical Characteristics ($V_{BIAS}(V_{CC}, V_{BS})=15V$, $T_J=25^{\circ}C$, unless otherwise specified.)

Symbol	Description	Min	Typ	Max	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	600	---	---	V	$I_{LK}=1mA$
I_{LK}	Zero Gate Voltage Drain Current	---	---	250	μA	$V_{DS}=600V$
$R_{DS(ON)}$	Drain to Source ON Resistance	---	2.4	3.0	Ω	$I_d = 1.5A$
V_{SD}	Diode Forward Voltage	---	---	1.2	V	$I_d = 1.5A$
V_{IH}	Logic "1" input voltage for HIN/LIN	2.8	---	---	V	
V_{IL}	Logic "0" input voltage for HIN/LIN	---	---	0.8	V	
V_{CCUV+}	VCC Supply Under-Voltage, Positive Going Threshold	11.2	12	12.8	V	
V_{CCUV-}	VCC supply Under-Voltage, Negative Going Threshold	10.2	11	11.8	V	
V_{CCUVH}	VCC Supply Under-Voltage Lock- Out Hysteresis	0.6	1	-	V	
V_{BSUV+}	VBS Supply Under-Voltage, Positive Going Threshold	9.4	10.2	11	V	
V_{BSUV-}	VBS supply Under-Voltage, Negative Going Threshold	8.4	9.2	10	V	
V_{BSUVH}	VBS Supply Under-Voltage Lock- Out Hysteresis	0.6	1	-	V	
I_{QBS}	Quiescent VBS Supply Current	---	75	120	μA	$V_{IN}=0V$ or $5V$
I_{QCC}	Quiescent VCC Supply Current	---	160	300	μA	$V_{IN}=0V$ or $5V$
I_{IN+}	Input Bias Current	---	25	50	μA	$V_{IN}=5V$
I_{IN-}	Input Bias Current	---	---	1	μA	$V_{IN}=0V$
T_{ON}	Input to Output Propagation Turn-On Delay Time	---	500	800	nS	
T_{OFF}	Input to Output Propagation Turn-Off Delay Time	---	200	400	nS	
$T_{FIL,IN}$	Input Filter Time (HIN, LIN)	---	100	---	nS	

MOSFET Avalanche Characteristics

Symbol	Description	Min	Typ	Max	Units	Conditions
E_{AS}	Single Pulse Avalanche Energy	---	157	---	mJ	$T_J=25^{\circ}C$, $L=36mH$, $I_{AS}=3A$, TO-252 package.
t_{rr}	Reverse Recovery Time	--	85	--	ns	$I_S=3A$, $di/dt=100A/us$

Input-Output Logic Level Table


HIN	LIN	VS
High	Low	HV
Low	High	PGND
Low	Low	*
High	High	**

* The VS voltage has two states. If the current flows from PGND to VS, the VS voltage is PGND; if the current flows from VS to HV, the VS voltage is HV

** Cross-conduction condition

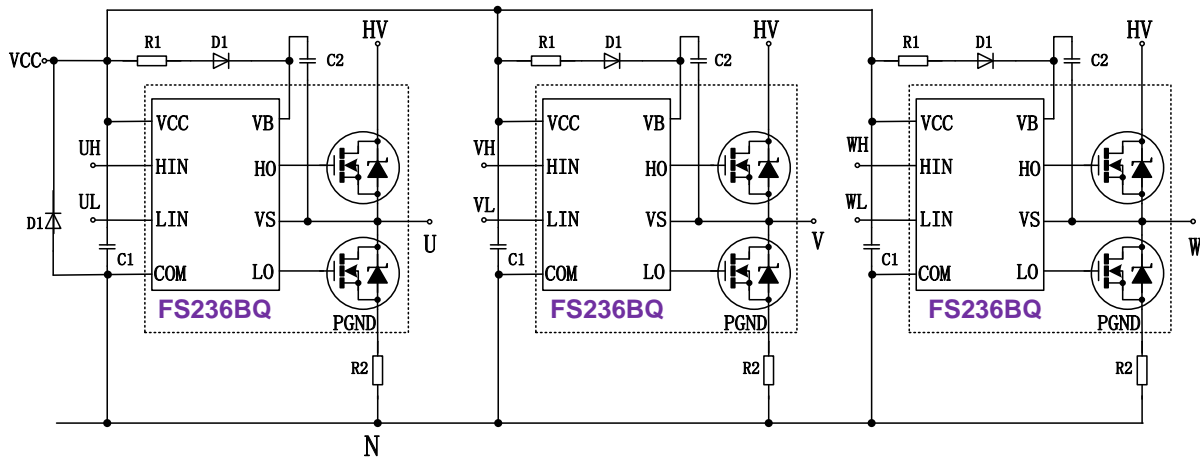
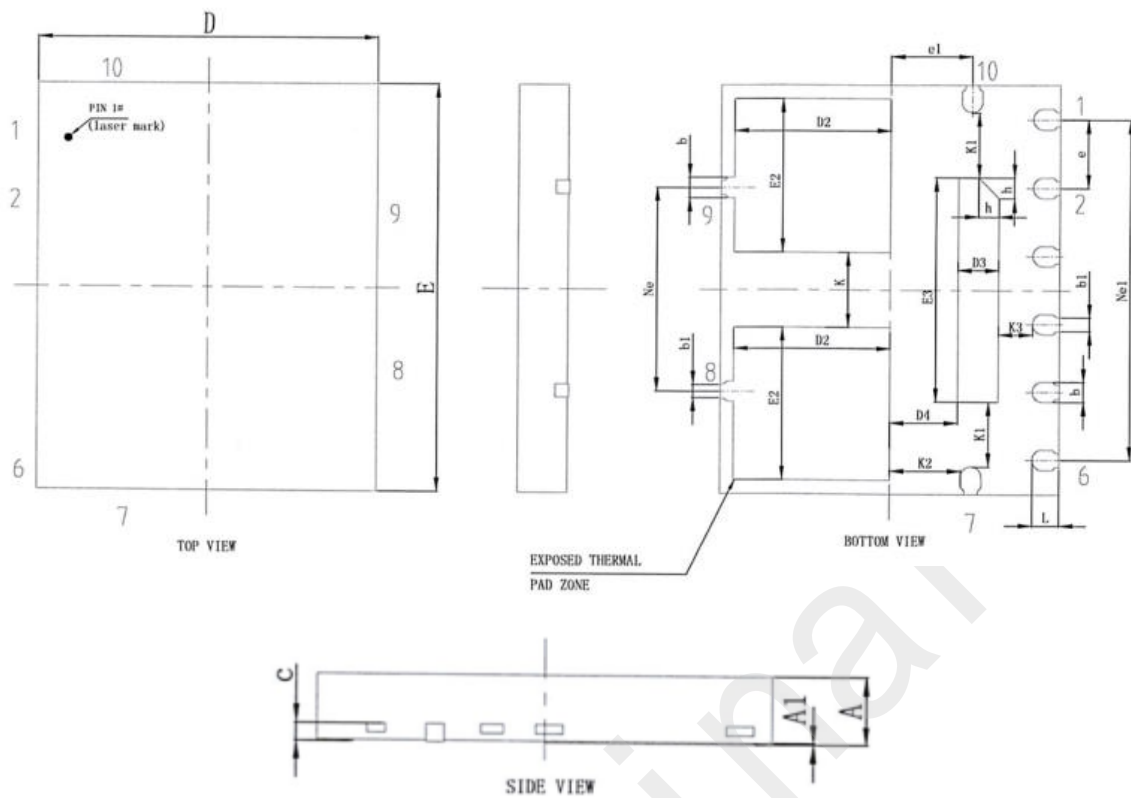
Typical Application


Figure: Typical Application Connection

1. In order to provide a good decoupling between VCC-COM and VB-VS terminals, the capacitors shown in the figure should be connected at these terminals and located very close to the module pins.
2. Value of the boot-strap capacitors depends upon the switching frequency.
3. Ground wires and output terminals, should be thick and short in order to avoid surge voltage and malfunction of HVIC.
4. It is recommended to connect high frequency non-inductive capacitor beside filter capacitor between HV&N with short wire to avoid surge destruction.
5. RC filtering capacitor maybe connected to inputs to prevent surge noise caused by wrong input signal.
6. High voltage (600V or more) and fast recovery type (less than 100ns) diodes D1 should be used in the bootstrap circuit. A resistor R1 (larger than 10ohm) must be added in series with the bootstrap diode.
7. To prevent ICs from surge destruction, it is recommended to insert a Zener diode D2 (18V,1W) nearby each pair of supply terminals.

Package Outline


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
b	0.25	0.30	0.35
b1	0.21REF		
c	0.203REF		
D	4.90	5.00	5.10
D2	2.20	2.30	2.40
D3	0.50	0.60	0.70
D4	0.95	1.00	1.05
e	1.00BSC		
e1	1.20BSC		
Ne	3.00BSC		
Ne1	5.00BSC		
E	5.90	6.00	6.10
E2	2.15	2.25	2.35
E3	3.20	3.30	3.40
L	0.35	0.40	0.45
h	0.25	0.30	0.35
K	1.10REF		
K1	0.95REF		

K2	1.05REF
K3	0.50REF

Part Number	Package Type	Marking ID	Package Method	Quantity
FS236BQ	QFN10L-5*6	FS236BQ	Tray	490

Preliminary

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